

INFORMATION DISCLOSURE STATEMENT

Applicant : Albertson *et al.*
App. No : 10/713,845
Filed : November 14, 2003
For : MULTI-LAYER INTERCONNECT
WITH ISOLATION LAYER
Examiner : George A. Goudreau
Art Unit : 1792

**INFORMATION DISCLOSURE STATEMENT FOR PLACEMENT IN FILE UNDER 37
C.F.R. § 1.97(i)**

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing in the above-identified application is a PTO/SB/08 Equivalent listing 12 references that have been cited in Office Actions for related cases U.S. Patent Application No. 11/560,504 (Attorney Docket No. MICRON.267DV1), filed November 16, 2006, and U.S. Patent Application No. 11/530,150 (Attorney Docket No. MICRON.267C1), filed September 8, 2006. Applicants request that the references be placed in the file in accordance with 37 CFR §1.97(i). Copies of the Office Actions are enclosed for your consideration. Copies of the U.S. Patent references are not submitted pursuant to 37 C.F.R. § 1.98(d).

Respectfully submitted,
KNOBBE, MARTENS, OLSON & BEAR, LLP

Dated: May 19, 2008

By: 

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